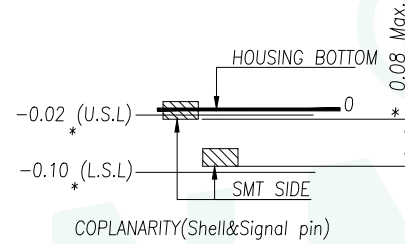


REV.	DESCRIPTION	ECN NO.	NAME	DATE

NOTE:
 1.FINISH:
 1-1.CONTACT: AU 1U" PLATING ON CONTACT AREA,
 100~200U" SN PLATING ON SOLDER TAILS,
 50U" NICKEL UNDERPLATING VOER ALL;
 1-2.SHELL: NO PLATING;
 2.PRODUCT SPECIFICATIONS:
 2-1.VOLTAGE RATING: 100V
 2-2.CURRENT RATING: 0.5A
 2-3.INSULATION RESISTANCE: 1000 MEG.OHM MIN
 2-4.CONTACT RESISTANCE: 100 MILL.OHM MAX
 2-5.OPERATION TEMPERATURE: -20° TO +85°



TF CARD PIN DEFINE			
PIN NO.	NAME	TYPE	DESCRIPTION
1	DAT2	I/O/PP	DATE LINE(BIT2)
2	CD/DAT3	I/O/PP	CARD DETECT DATE LIN(BIT3)
3	CMD	PP	COMMAND RESPONSE
4	VDD	S	SUPPLY VOLTAGE
5	CLX	I	CLOCK
6	VSS	S	SUPPLY VOLTAGE GROUND
7	DAT0	I/O/PP	DATE LINE(BIT0)
8	DAT1	I/O/PP	DATE LINE(BIT1)

GENERAL TOLERANCE	DONGGUAN BAOXUN PRECISION TECHNOLOGY CO., LTD				
DIM. TOL.	TITLE: T-FLASH CARD HINGED H1.6 掀盖卡				
X	±0.30	DWG. NO.: TF01-GZ8PH16			DRAWN: MAX
X.X	±0.25	PART NO.: TF01-GZ8PH16			CHECKED: ELLA
X.XX	±0.15	UNIT: mm	SCALE: none	SHEET: 1 of 1	APPROVED: WILL
X.XXX	±0.10	DWG. SIZE: A4	LAYER: bxconn		

